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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I²C, SCI, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	52
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.63V
Data Converters	A/D 16x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamda1j15b-abt

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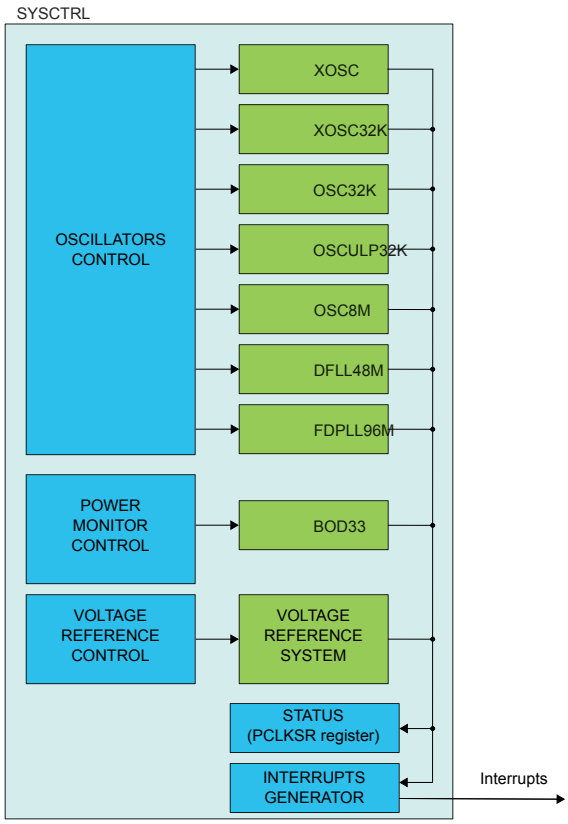
19.3 Block Diagram

Figure 19-1. SYSCTRL Block Diagram



19.4 Signal Description

Signal Name	Types	Description
XIN	Analog Input	Multipurpose Crystal Oscillator or external clock generator input
XOUT	Analog Output	External Multipurpose Crystal Oscillator output
XIN32	Analog Input	32kHz Crystal Oscillator or external clock generator input
XOUT32	Analog Output	32kHz Crystal Oscillator output

The I/O lines are automatically selected when XOSC or XOSC32K are enabled. Refer to *Oscillator Pinout*.

Related Links

I/O Multiplexing and Considerations

19.5 Product Dependencies

In order to use this peripheral, other parts of the system must be configured correctly, as described below.

To force the oscillator to run in standby mode, the RUNSTDBY bit must be written to one. The oscillator will then run in standby mode when requested by a peripheral (ONDEMAND is one). To force an oscillator to always run in standby mode, and not only when requested by a peripheral, the ONDEMAND bit must be written to zero and RUNSTDBY must be written to one.

The next table shows the behavior in the different sleep modes, depending on the settings of ONDEMAND and RUNSTDBY.

Table 19-2. Behavior in the different sleep modes

Sleep mode	ONDEMAND	RUNSTDBY	Behavior
Idle 0, 1, 2	0	X	Run
Idle 0, 1, 2	1	X	Run when requested by a peripheral
Standby	0	0	Stop
Standby	0	1	Run
Standby	1	0	Stop
Standby	1	1	Run when requested by a peripheral

Note: This does not apply to the OSCULP32K oscillator, which is always running and cannot be disabled.

19.6.2 External Multipurpose Crystal Oscillator (XOSC) Operation

The XOSC can operate in two different modes:

- External clock, with an external clock signal connected to the XIN pin
- Crystal oscillator, with an external 0.4-32MHz crystal

The XOSC can be used as a clock source for generic clock generators, as described in the *GCLK – Generic Clock Controller*.

At reset, the XOSC is disabled, and the XIN/XOUT pins can be used as General Purpose I/O (GPIO) pins or by other peripherals in the system. When XOSC is enabled, the operating mode determines the GPIO usage. When in crystal oscillator mode, the XIN and XOUT pins are controlled by the SYSCTRL, and GPIO functions are overridden on both pins. When in external clock mode, only the XIN pin will be overridden and controlled by the SYSCTRL, while the XOUT pin can still be used as a GPIO pin.

The XOSC is enabled by writing a one to the Enable bit in the External Multipurpose Crystal Oscillator Control register (XOSC.ENABLE). To enable the XOSC as a crystal oscillator, a one must be written to the XTAL Enable bit (XOSC.XTALEN). If XOSC.XTALEN is zero, external clock input will be enabled.

When in crystal oscillator mode (XOSC.XTALEN is one), the External Multipurpose Crystal Oscillator Gain (XOSC.GAIN) must be set to match the external crystal oscillator frequency. If the External Multipurpose Crystal Oscillator Automatic Amplitude Gain Control (XOSC.AMPGC) is one, the oscillator amplitude will be automatically adjusted, and in most cases result in a lower power consumption.

The XOSC will behave differently in different sleep modes based on the settings of XOSC.RUNSTDBY, XOSC.ONDEMAND and XOSC.ENABLE:

Value	Description
	XOSC32K.ONDEMAND is zero, the clock source will always be running in standby sleep mode.

Bit 5 – AAMPEN: Automatic Amplitude Control Enable

Value	Description
0	The automatic amplitude control for the crystal oscillator is disabled.
1	The automatic amplitude control for the crystal oscillator is enabled.

Bit 3 – EN32K: 32kHz Output Enable
This bit controls the connections between the I/O pads and the external clock or crystal oscillator:

Value	Description
0	The 32kHz output is disabled.
1	The 32kHz output is enabled.

Bit 2 – XTALEN: Crystal Oscillator Enable
This bit controls the connections between the I/O pads and the external clock or crystal oscillator:

Value	Description
0	External clock connected on XIN32. XOUT32 can be used as general-purpose I/O.
1	Crystal connected to XIN32/XOUT32.

Bit 1 – ENABLE: Oscillator Enable

Value	Description
0	The oscillator is disabled.
1	The oscillator is enabled.

19.8.7 32kHz Internal Oscillator (OSC32K) Control

Name: OSC32K
Offset: 0x18 [ID-00003d5d]
Reset: 0x003F0080
Property: Write-Protected

Writing a zero to this bit has no effect.
Writing a one to this bit clears the Early Warning interrupt flag.

20.8.7 Status

Name: STATUS
Offset: 0x7 [ID-000004d0]
Reset: 0x00
Property: –

Bit	7	6	5	4	3	2	1	0
	SYNCBUSY							
Access	R							
Reset	0							

Bit 7 – SYNCBUSY: Synchronization Busy
This bit is cleared when the synchronization of registers between clock domains is complete.

This bit is set when the synchronization of registers between clock domains is started.

20.8.8 Clear

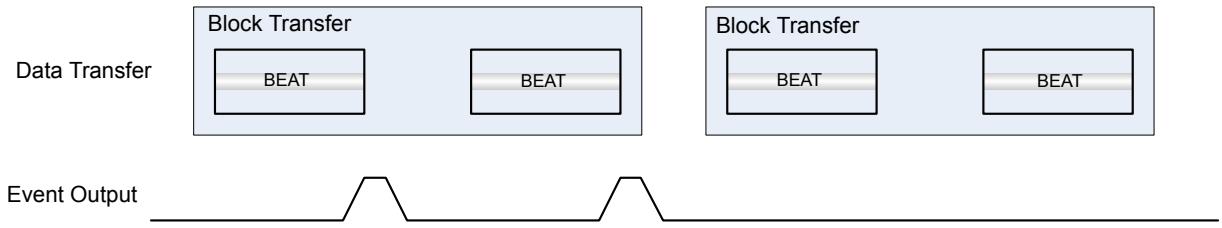
Name: CLEAR
Offset: 0x8 [ID-000004d0]
Reset: 0x00
Property: Write-Protected, Write-Synchronized

Bit	7	6	5	4	3	2	1	0
	CLEAR[7:0]							
Access	W	W	W	W	W	W	W	W
Reset	0	0	0	0	0	0	0	0

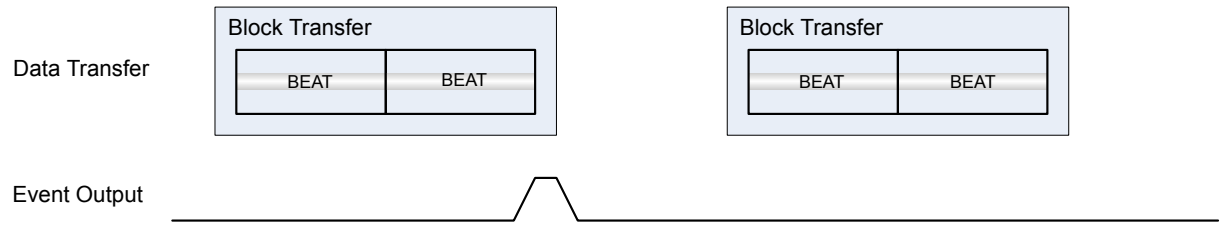
Bits 7:0 – CLEAR[7:0]: Watchdog Clear
Writing 0xA5 to this register will clear the Watchdog Timer and the watchdog time-out period is restarted.
Writing any other value will issue an immediate system reset.

Figure 22-15. Event Output Generation

Beat Event Output



Block Event Output



22.6.3.6 Aborting Transfers

Transfers on any channel can be aborted gracefully by software by disabling the corresponding DMA channel. It is also possible to abort all ongoing or pending transfers by disabling the DMAC.

When a DMA channel disable request or DMAC disable request is detected:

- Ongoing transfers of the active channel will be disabled when the ongoing beat transfer is completed and the write-back memory section is updated. This prevents transfer corruption before the channel is disabled.
- All other enabled channels will be disabled in the next clock cycle.

The corresponding Channel Enable bit in the Channel Control A register is cleared (CHCTRLA.ENABLE=0) when the channel is disabled.

The corresponding DMAC Enable bit in the Control register is cleared (CTRL.DMAENABLE=0) when the entire DMAC module is disabled.

22.6.3.7 CRC Operation

A cyclic redundancy check (CRC) is an error detection technique used to find errors in data. It is commonly used to determine whether the data during a transmission, or data present in data and program memories has been corrupted or not. A CRC takes a data stream or a block of data as input and generates a 16- or 32-bit output that can be appended to the data and used as a checksum.

When the data is received, the device or application repeats the calculation: If the new CRC result does not match the one calculated earlier, the block contains a data error. The application will then detect this and may take a corrective action, such as requesting the data to be sent again or simply not using the incorrect data.

The CRC engine in DMAC supports two commonly used CRC polynomials: CRC-16 (CRC-CCITT) and CRC-32 (IEEE 802.3). Typically, applying CRC-n (CRC-16 or CRC-32) to a data block of arbitrary length will detect any single alteration that is ≤n bits in length, and will detect the fraction 1-2-n of all longer error bursts.

Bit	31	30	29	28	27	26	25	24
	CRCDATAIN[31:24]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	23	22	21	20	19	18	17	16
	CRCDATAIN[23:16]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	15	14	13	12	11	10	9	8
	CRCDATAIN[15:8]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
	CRCDATAIN[7:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 31:0 – CRCDATAIN[31:0]: CRC Data Input

These bits store the data for which the CRC checksum is computed. A new CRC Checksum is ready (CRCBEAT+ 1) clock cycles after the CRCDATAIN register is written.

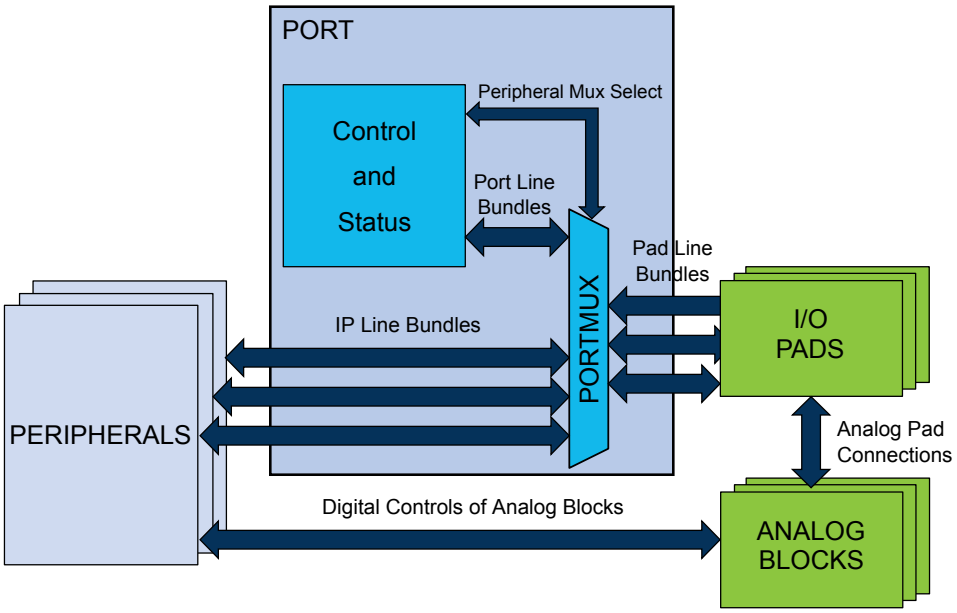
22.8.4 CRC Checksum

The CRCCHKSUM represents the 16- or 32-bit checksum value and the generated CRC. The register is reset to zero by default, but it is possible to reset all bits to one by writing the CRCCHKSUM register directly. It is possible to write this register only when the CRC module is disabled. If CRC-32 is selected and the CRC Status Busy flag is cleared (i.e., CRC generation is completed or aborted), the bit reversed (bit 31 is swapped with bit 0, bit 30 with bit 1, etc.) and complemented result will be read from CRCCHKSUM. If CRC-16 is selected or the CRC Status Busy flag is set (i.e., CRC generation is ongoing), CRCCHKSUM will contain the actual content.

Name: CRCCHKSUM
Offset: 0x08 [ID-00001ece]
Reset: 0x00000000
Property: PAC Write-Protection, Enable-Protected

25.3 Block Diagram

Figure 25-1. PORT Block Diagram



25.4 Signal Description

Table 25-1. Signal description for PORT

Signal name	Type	Description
Pxy	Digital I/O	General-purpose I/O pin y in group x

Refer to the *I/O Multiplexing and Considerations* for details on the pin mapping for this peripheral. One signal can be mapped on several pins.

Related Links

I/O Multiplexing and Considerations

25.5 Product Dependencies

In order to use this peripheral, other parts of the system must be configured correctly as following.

25.5.1 I/O Lines

The I/O lines of the PORT are mapped to pins of the physical device. The following naming scheme is used:

Each line bundle with up to 32 lines is assigned an identifier 'xy', with letter x=A, B, C… and two-digit number y=00, 01, …31. Examples: A24, C03.

PORT pins are labeled 'Pxy' accordingly, for example PA24, PC03. This identifies each pin in the device uniquely.

Each pin may be controlled by one or more peripheral multiplexer settings, which allow the pad to be routed internally to a dedicated peripheral function. When the setting is enabled, the selected peripheral

Name: CTRLB
Offset: 0x04 [ID-00000fa7]
Reset: 0x00000000
Property: PAC Write-Protection, Enable-Protected, Write-Synchronized

Bit	31	30	29	28	27	26	25	24
Access								
Reset								

Bit	23	22	21	20	19	18	17	16
							RXEN	TXEN
Access							R/W	R/W
Reset							0	0

Bit	15	14	13	12	11	10	9	8
			PMODE			ENC	SFDE	COLDEN
Access			R/W			R/W	R/W	R/W
Reset			0			0	0	0

Bit	7	6	5	4	3	2	1	0
		SBMODE				CHSIZE[2:0]		
Access		R/W				R/W	R/W	R/W
Reset		0				0	0	0

Bit 17 – RXEN: Receiver Enable
Writing '0' to this bit will disable the USART receiver. Disabling the receiver will flush the receive buffer and clear the FERR, PERR and BUFOVF bits in the STATUS register.

Writing '1' to CTRLB.RXEN when the USART is disabled will set CTRLB.RXEN immediately. When the USART is enabled, CTRLB.RXEN will be cleared, and SYNCBUSY.CTRLB will be set and remain set until the receiver is enabled. When the receiver is enabled, CTRLB.RXEN will read back as '1'.

Writing '1' to CTRLB.RXEN when the USART is enabled will set SYNCBUSY.CTRLB, which will remain set until the receiver is enabled, and CTRLB.RXEN will read back as '1'.

This bit is not enable-protected.

Value	Description
0	The receiver is disabled or being enabled.
1	The receiver is enabled or will be enabled when the USART is enabled.

Bit 16 – TXEN: Transmitter Enable
Writing '0' to this bit will disable the USART transmitter. Disabling the transmitter will not become effective until ongoing and pending transmissions are completed.

Writing '1' to CTRLB.TXEN when the USART is disabled will set CTRLB.TXEN immediately. When the USART is enabled, CTRLB.TXEN will be cleared, and SYNCBUSY.CTRLB will be set and remain set until the transmitter is enabled. When the transmitter is enabled, CTRLB.TXEN will read back as '1'.

Writing '1' to CTRLB.TXEN when the USART is enabled will set SYNCBUSY.CTRLB, which will remain set until the receiver is enabled, and CTRLB.TXEN will read back as '1'.

Bit	15	14	13	12	11	10	9	8
								DATA[8:8]
Access								R/W
Reset								0

Bit	7	6	5	4	3	2	1	0
	DATA[7:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bits 8:0 – DATA[8:0]: Data
Reading these bits will return the contents of the receive data buffer. The register should be read only when the Receive Complete Interrupt Flag bit in the Interrupt Flag Status and Clear register (INTFLAG.RXC) is set.

Writing these bits will write the transmit data buffer. This register should be written only when the Data Register Empty Interrupt Flag bit in the Interrupt Flag Status and Clear register (INTFLAG.DRE) is set.

29.8.11 Debug Control

Name: DBGCTRL
Offset: 0x30 [ID-00000e74]
Reset: 0x00
Property: PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
								DBGSTOP
Access								R/W
Reset								0

Bit 0 – DBGSTOP: Debug Stop Mode
This bit controls the functionality when the CPU is halted by an external debugger.

Value	Description
0	The baud-rate generator continues normal operation when the CPU is halted by an external debugger.
1	The baud-rate generator is halted when the CPU is halted by an external debugger.

Bit	31	30	29	28	27	26	25	24
Access								
Reset								

Bit	23	22	21	20	19	18	17	16
						ACKACT	CMD[1:0]	
Access						R/W	R/W	R/W
Reset						0	0	0

Bit	15	14	13	12	11	10	9	8
							QCEN	SMEN
Access							R	R/W
Reset							0	0

Bit	7	6	5	4	3	2	1	0
Access								
Reset								

Bit 18 – ACKACT: Acknowledge Action

This bit defines the I^2C master's acknowledge behavior after a data byte is received from the I^2C slave. The acknowledge action is executed when a command is written to CTRLB.CMD, or if smart mode is enabled (CTRLB.SMEN is written to one), when DATA.DATA is read.

This bit is not enable-protected.

This bit is not write-synchronized.

Value	Description
0	Send ACK.
1	Send NACK.

Bits 17:16 – CMD[1:0]: Command

Writing these bits triggers a master operation as described below. The CMD bits are strobe bits, and always read as zero. The acknowledge action is only valid in master read mode. In master write mode, a command will only result in a repeated start or stop condition. The CTRLB.ACKACT bit and the CMD bits can be written at the same time, and then the acknowledge action will be updated before the command is triggered.

Commands can only be issued when either the Slave on Bus interrupt flag (INTFLAG.SB) or Master on Bus interrupt flag (INTFLAG.MB) is '1'.

If CMD 0x1 is issued, a repeated start will be issued followed by the transmission of the current address in ADDR.ADDR. If another address is desired, ADDR.ADDR must be written instead of the CMD bits. This will trigger a repeated start followed by transmission of the new address.

Issuing a command will set the System Operation bit in the Synchronization Busy register (SYNCBUSY.SYSOP).

  - Suitable for a wide range of sample frequencies *fs*, including 32kHz, 44.1kHz, 48kHz, 88.2kHz, 96kHz, and 192kHz
  - 16×*fs* to 1024×*fs* Master Clock generated for external audio CODECs
- Master, slave, and controller modes:
  - Master: Data received/transmitted based on internally-generated clocks. Output Serial Clock on SCKn pin, Master Clock on MCKn pin, and Frame Sync Clock on FSn pin
  - Slave: Data received/transmitted based on external clocks on Serial Clock pin (SCKn) or Master Clock pin (MCKn)
  - Controller: Only output internally generated Master clock (MCKn), Serial Clock (SCKn), and Frame Sync Clock (FSn)
- Individual enabling and disabling of Clock Units and Serializers
- DMA interfaces for each Serializer receiver or transmitter to reduce processor overhead:
  - Either one DMA channel for all data slots or
  - One DMA channel per data channel in stereo
- Smart Data Holding register management to avoid data slots mix after overrun or underrun

31.3 Block Diagram

Figure 31-1. I²S Block Diagram

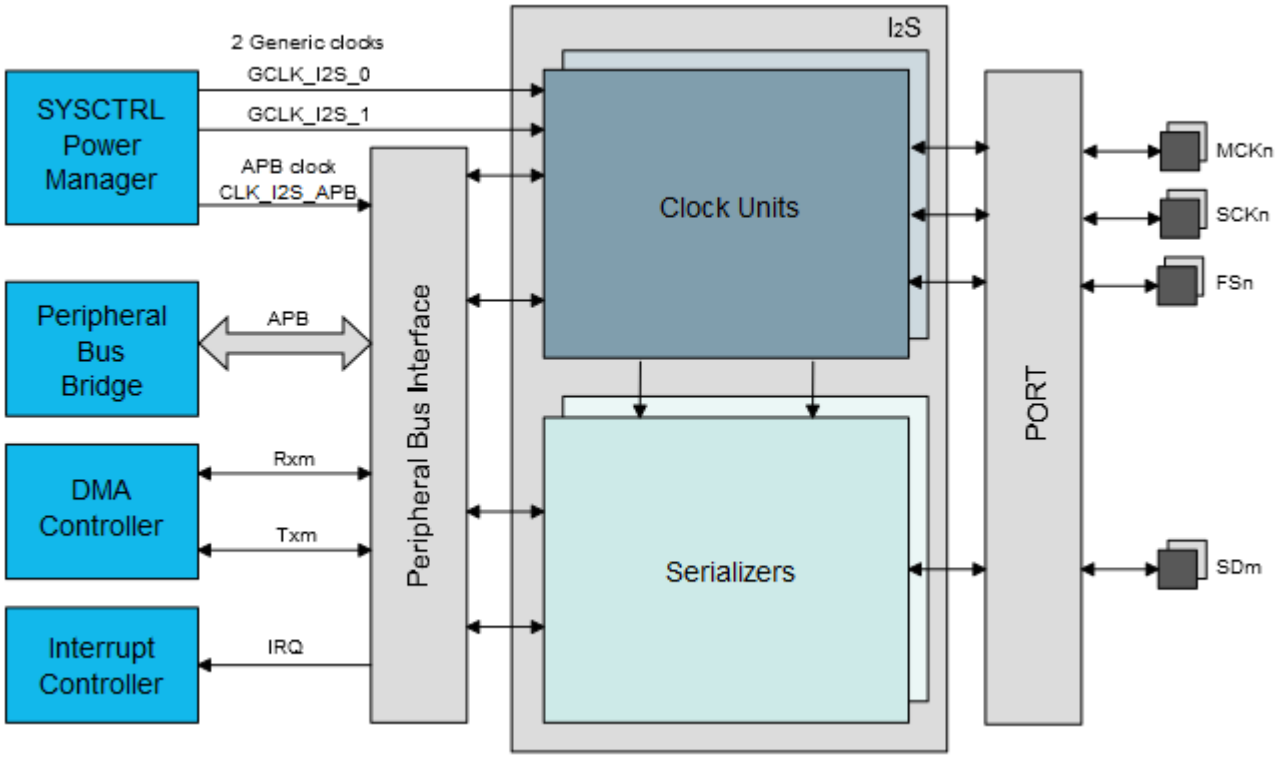
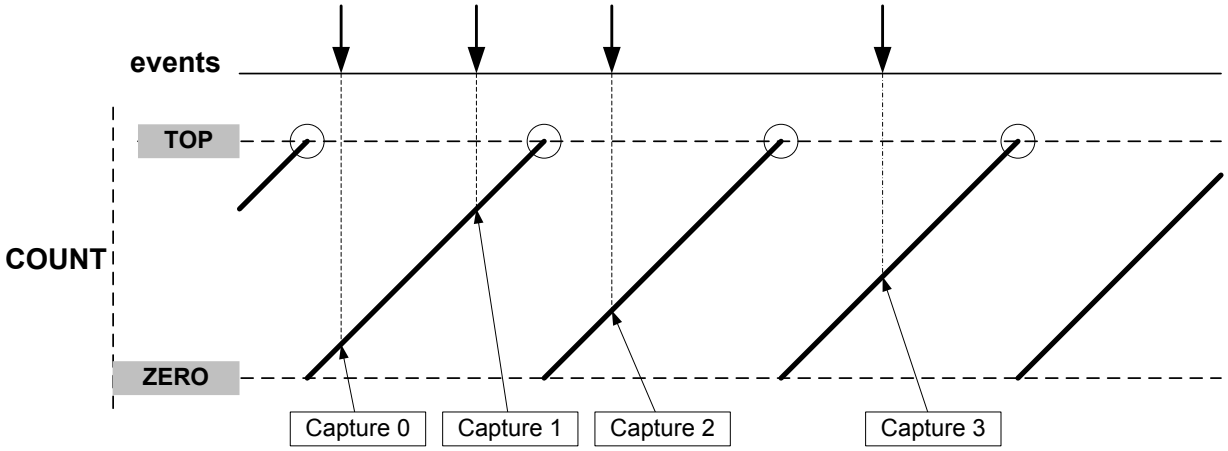


Figure 32-9. Input Capture Timing



The TC can detect capture overflow of the input capture channels: When a new capture event is detected while the Capture Interrupt flag (INTFLAG.MCx) is still set, the new timestamp will not be stored and INTFLAG.ERR will be set.

Period and Pulse-Width (PPW) Capture Action

The TC can perform two input captures and restart the counter on one of the edges. This enables the TC to measure the pulse width and period and to characterize the frequency *f* and duty cycle of an input signal:

$$f = \frac{1}{T} \qquad \text{dutyCycle} = \frac{t_p}{T}$$

Selecting PWP (pulse-width, period) in the Event Action bit group in the Event Control register (EVCTRL.EVACT) enables the TC to perform one capture action on the rising edge and the other one on the falling edge. The period *T* will be captured into CC1 and the pulse width t_p in CC0. EVCTRL.EVACT=PPW (period and pulse-width)offers identical functionality, but will capture *T* into CC0 and t_p into CC1.

The TC Event Input Invert Enable bit in the Event Control register (EVCTRL.TCINV) is used to select whether the wraparound should occur on the rising edge or the falling edge. If EVCTRL.TCINV=1, the wraparound will happen on the falling edge.

To fully characterize the frequency and duty cycle of the input signal, activate capture on CC0 and CC1 by writing 0x3 to the Capture Channel x Enable bit group in the Control C register (CTRLC.CPTEN). When only one of these measurements is required, the second channel can be used for other purposes.

The TC can detect capture overflow of the input capture channels: When a new capture event is detected while the Capture Interrupt flag (INTFLAG.MCx) is still set, the new timestamp will not be stored and INTFLAG.ERR will be set.

Notes:

1. DMA request set on overflow, underflow or re-trigger conditions.
2. Can perform capture or generate recoverable fault on an event input.
3. In capture or circular modes.
4. On event input, either action can be executed:
   – re-trigger counter
   – control counter direction
   – stop the counter
   – decrement the counter
   – perform period and pulse width capture
   – generate non-recoverable fault
5. On event input, either action can be executed:
   – re-trigger counter
   – increment or decrement counter depending on direction
   – start the counter
   – increment or decrement counter based on direction
   – increment counter regardless of direction
   – generate non-recoverable fault

33.6.4.1 DMA Operation

The TCC can generate the following DMA requests:

Counter overflow (OVF)	If the Ones-shot Trigger mode in the control A register (CTRLA.DMAOS) is written to '0', the TCC generates a DMA request on each cycle when an update condition (overflow, underflow or re-trigger) is detected. When an update condition (overflow, underflow or re-trigger) is detected while CTRLA.DMAOS=1, the TCC generates a DMA trigger on the cycle following the DMA One-Shot Command written to the Control B register (CTRLBSET.CMD=DMAOS). In both cases, the request is cleared by hardware on DMA acknowledge.
Channel Match (MCx)	A DMA request is set only on a compare match if CTRLA.DMAOS=0. The request is cleared by hardware on DMA acknowledge. When CTRLA.DMAOS=1, the DMA requests are not generated.
Channel Capture (MCx)	For a capture channel, the request is set when valid data is present in the CCx register, and cleared once the CCx register is read. In this operation mode, the CTRLA.DMAOS bit value is ignored.

DMA Operation with Circular Buffer

When circular buffer operation is enabled, the buffer registers must be written in a correct order and synchronized to the update times of the timer. The DMA triggers of the TCC provide a way to ensure a safe and correct update of circular buffers.

Note: Circular buffer are intended to be used with RAMP2, RAMP2A and DSBOTH operation only.

DMA Operation with Circular Buffer in RAMP and RAMP2A Mode

When a CCx channel is selected as a circular buffer, the related DMA request is not set on a compare match detection, but on start of ramp B.

Name: PERB
Offset: 0x6C [ID-00002e48]
Reset: 0xFFFFFFFF
Property: Write-Synchronized, Read-Synchronized

Bit	31	30	29	28	27	26	25	24
Access								
Reset								

Bit	23	22	21	20	19	18	17	16
	PERB[17:10]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

Bit	15	14	13	12	11	10	9	8
	PERB[9:2]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

Bit	7	6	5	4	3	2	1	0
	PERB[1:0]		DITHERB[5:0]					
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	1	1	1	1	1	1	1	1

Bits 23:6 – PERB[17:0]: Period Buffer Value
These bits hold the value of the period buffer register. The value is copied to PER register on UPDATE condition.

Note: When the TCC is configured as 16-bit timer/counter, the excess bits are read zero.

Note: This bit field occupies the MSB of the register, [23:m]. m is dependent on the Resolution bit in the Control A register (CTRLA.RESOLUTION):

CTRLA.RESOLUTION	Bits [23:m]
0x0 - NONE	23:0
0x1 - DITH4	23:4
0x2 - DITH5	23:5
0x3 - DITH6	23:6 (depicted)

Bits 5:0 – DITHERB[5:0]: Dithering Buffer Cycle Number
These bits represent the PER.DITHER bits buffer. When the double buffering is enabled, the value of this bit field is copied to the PER.DITHER bits on an UPDATE condition.
Note: This bit field consists of the n LSB of the register. n is dependent on the value of the Resolution bits in the Control A register (CTRLA.RESOLUTION):

Offset	Name	Bit Pos.								
0x1B	Reserved									
0x1C	INTFLAG	7:0	RAMACER	UPRSM	DNRSM	WAKEUP	RST	HSOF		
0x1D		15:8							DDISC	DCONN
0x1E	Reserved									
0x1F	Reserved									
0x20	PINTSMRY	7:0	PINT[7:0]							
0x21		15:8	PINT[15:8]							
0x22	Reserved									
0x23										

Table 34-6. Host Pipe Register n

Offset	Name	Bit Pos.								
0x1m0	PCFGn	7:0			PTYPE[2:0]			BK	PTOKEN[1:0]	
0x1m1	Reserved									
0x1m2	Reserved									
0x1m3	BINTERVAL	7:0	BINTERVAL[7:0]							
0x1m4	PSTATUSCLRn	7:0	BK1RDY	BK0RDY		PFREEZE		CURBK		DTGL
0x1m5	PSTATUSETn	7:0	BK1RDY	BK0RDY		PFREEZE		CURBK		DTGL
0x1m6	PSTATUSn	7:0	BK1RDY	BK0RDY		PFREEZE		CURBK		DTGL
0x1m7	PINTFLAGn	7:0			STALL	TXSTP	PERR	TRFAIL	TRCPT1	TRCPT0
0x1m8	PINTENCLRn	7:0			STALL	TXSTP	PERR	TRFAIL	TRCPT1	TRCPT0
0x1m9	PINTENSETn	7:0			STALL	TXSTP	PERR	TRFAIL	TRCPT1	TRCPT0
0x1mA	Reserved									
0x1mB	Reserved									

Table 34-7. Host Pipe n Descriptor Bank 0

Offset 0x n0 + index	Name	Bit Pos.								
0x00	ADDR	7:0	ADD[7:0]							
0x01		15:8	ADD[15:8]							
0x02		23:16	ADD[23:16]							
0x03		31:24	ADD[31:24]							
0x04	PCKSIZE	7:0	BYTE_COUNT[7:0]							
0x05		15:8	MULTI_PACKET_SIZE[1:0]		BYTE_COUNT[13:8]					
0x06		23:16	MULTI_PACKET_SIZE[9:2]							
0x07		31:24	AUTO_ZLP	SIZE[2:0]			MULTI_PACKET_SIZE[13:10]			
0x08	EXTREG	7:0	VARIABLE[3:0]				SUBPID[3:0]			
0x09		15:8		VARIABLE[10:4]						
0x0A	STATUS_BK	7:0							ERRORFLOW	CRCERR
0x0B		15:8								
0x0C	CTRL_PIPE	7:0		PDADDR[6:0]						
0x0D		15:8	PEPMAX[3:0]				PEPNUM[3:0]			
0x0E	STATUS_PIPE	7:0	ERCNT[2:0]			CRC16ER	TOUTER	PIDER	DAPIDER	DTGLER
0x0F		15:8								

37. DAC – Digital-to-Analog Converter

37.1 Overview

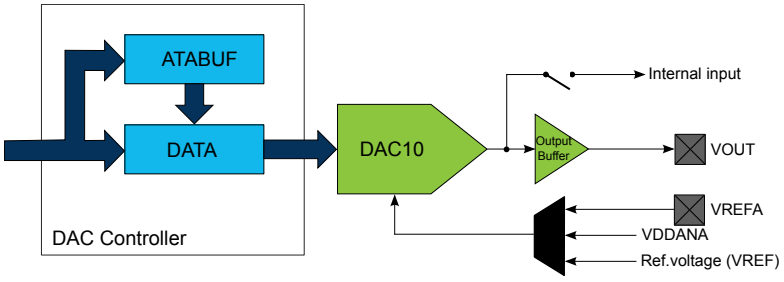
The Digital-to-Analog Converter (DAC) converts a digital value to a voltage. The DAC has one channel with 10-bit resolution, and it is capable of converting up to 350,000 samples per second (350ksps).

37.2 Features

- DAC with 10-bit resolution
- Up to 350ksps conversion rate
- Multiple trigger sources
- High-drive capabilities
- Output can be used as input to the Analog Comparator (AC)
- DMA support

37.3 Block Diagram

Figure 37-1. DAC Block Diagram



37.4 Signal Description

Signal Name	Type	Description
VOUT	Analog output	DAC output
VREFA	Analog input	External reference

Related Links

I/O Multiplexing and Considerations

37.5 Product Dependencies

In order to use this peripheral, other parts of the system must be configured correctly, as described below.

37.5.1 I/O Lines

Using the DAC Controller's I/O lines requires the I/O pins to be configured using the port configuration (PORT).

39.10 NVM Characteristics

Table 39-32. Maximum Operating Frequency

V_{DD} range	NVM Wait States	Maximum Operating Frequency	Unit
2.7V to 3.63V	0	24	MHz
	1	48	MHz

Note that on this flash technology, a max number of 8 consecutive write is allowed per row. Once this number is reached, a row erase is mandatory.

Table 39-33. Flash Endurance and Data Retention

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Retention after up to 25k	Average ambient 55°C	Ret_{NVM25k}	10	50	-	Years
Retention after up to 2.5k	Average ambient 55°C	$Ret_{NVM2.5k}$	20	100	-	Years
Retention after up to 100	Average ambient 55°C	Ret_{NVM100}	25	>100	-	Years
Cycling Endurance(1)	–40°C < Ta < 105°C	Cyc_{NVM}	25k	150k	-	Cycles

An endurance cycle is a write and an erase operation.

Table 39-34. EEPROM Emulation(1) Endurance and Data Retention

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Retention after up to 100k	Average ambient 55°C	$Ret_{EEPROM100k}$	10	50	-	Years
Retention after up to 10k	Average ambient 55°C	$Ret_{EEPROM10k}$	20	100	-	Years
Cycling Endurance(2)	–40°C < Ta < 105°C	Cyc_{EEPROM}	100k	600k	-	Cycles

The EEPROM emulation is a software emulation described in the App note AT03265. An endurance cycle is a write and an erase operation.

Table 39-35. NVM Characteristics

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Page programming time	-	t_{FPP}	-	-	2.5	ms
Row erase time	-	t_{FRE}	-	-	6	ms
DSU chip erase time (CHIP_ERASE)	-	t_{FCE}	-	-	240	ms

39.11 Oscillators Characteristics

39.11.1 Crystal Oscillator (XOSC) Characteristics

39.11.1.1 Digital Clock Characteristics

The following table describes the characteristics for the oscillator when a digital clock is applied on XIN.

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
	at 25°C, over [–40, +105]°C, over [2.7, 3.63]V					
	Calibrated against a 32.768kHz reference at 25°C, at VDD = 3.3V		31.457	32.768	34.078	
	Calibrated against a 32.768kHz reference at 25°C, over [2.7, 3.63]V		31.293	32.768	34.570	
Duty Cycle		Duty	-	50	-	%

1. These values are based on simulation. These values are not covered by test limits in production or characterization.
2. This oscillator is always on.

39.11.6 8MHz RC Oscillator (OSC8M) Characteristics

Table 39-44. Internal 8MHz RC Oscillator Characteristics

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Output frequency	Calibrated against a 8MHz reference at 25°C, over [–10, +70]C, over [2.7, 3.6]V	f_{OUT}	7.84	8	8.16	MHz
	Calibrated against a 8MHz reference at 25°C, over [–10, +105]°C, over [2.7, 3.6]V		7.80	8	8.20	
	Calibrated against a 8MHz reference at 25°C, over [–40, +105]°C, over [2.7, 3.6]V		7.66	8	8.34	
	Calibrated against a 8MHz reference at 25°C,		7.88	8	8.12	

Symbol	Parameter		Conditions	Min.	Typ.	Max.	Units
t_{BUF}	Bus free time between a STOP and a START condition		f_{SCL} > 100kHz	t_{LOW}	-	-	
$t_{SU;STA}$	Setup time for a repeated START condition		f_{SCL} > 100kHz, Master	t_{LOW}+7	-	-	
$t_{HD;DAT}$	Data hold time		f_{SCL} > 100kHz, Master	9	-	12	
$t_{SU;DAT}$	Data setup time		f_{SCL} > 100kHz, Master	104	-	-	
$t_{SU;STO}$	Setup time for STOP condition		f_{SCL} > 100kHz, Master	t_{LOW}+9	-	-	
$t_{SU;DAT;rx}$	Data setup time (receive mode)		f_{SCL} > 100kHz, Slave	51	-	56	
$t_{HD;DAT;tx}$	Data hold time (send mode)		f_{SCL} > 100kHz, Slave	71	90	138	

1. These values are based on simulation. These values are not covered by test limits in production.

2. C_b = Capacitive load on each bus line. Otherwise noted, value of C_b set to 20pF.

39.14.4 SWD Timing

Figure 39-16. SWD Interface Signals

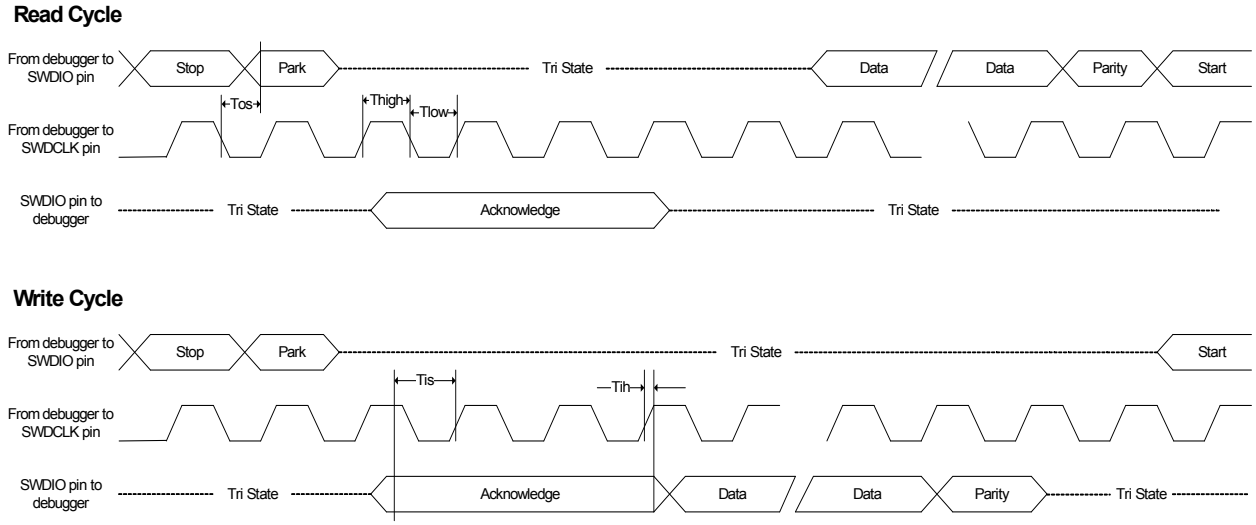


Table 39-51. SWD Timings(1)

Symbol	Parameter	Conditions	Min.	Max.	Units
T_{high}	SWDCLK High period	V_{VDDIO} from 3.0 V to 3.6 V, maximum external capacitor = 40 pF	10	500000	ns
T_{low}	SWDCLK Low period		10	500000	
T_{os}	SWDIO output skew to falling edge SWDCLK		-5	5	